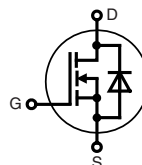


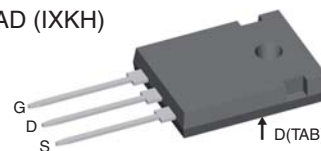
# CoolMOS™ 1) Power MOSFET

N-Channel Enhancement Mode  
Low  $R_{DS(on)}$ , High  $V_{DSS}$  MOSFET  
Ultra low gate charge

$$\begin{aligned} I_{D25} &= 70 \text{ A} \\ V_{DSS} &= 600 \text{ V} \\ R_{DS(on) \text{ max}} &= 0.045 \Omega \end{aligned}$$



TO-247 AD (IXKH)



| MOSFET               |                                                            |                 |          |
|----------------------|------------------------------------------------------------|-----------------|----------|
| Symbol               | Conditions                                                 | Maximum Ratings |          |
| $V_{DSS}$            | $T_{VJ} = 25^\circ\text{C}$                                | 600             | V        |
| $V_{GS}$             |                                                            | $\pm 20$        | V        |
| $I_{D25}$            | $T_C = 25^\circ\text{C}$                                   | 70              | A        |
| $I_{D90}$            | $T_C = 90^\circ\text{C}$                                   | 48              | A        |
| $E_{AS}$<br>$E_{AR}$ | single pulse<br>repetitive                                 | 1950<br>3       | mJ<br>mJ |
| $dV/dt$              | MOSFET $dV/dt$ ruggedness $V_{DS} = 0 \dots 480 \text{ V}$ | 50              | V/ns     |

## Features

- fast CoolMOS™ 1) power MOSFET 4<sup>th</sup> generation
- High blocking capability
- Lowest resistance
- Avalanche rated for unclamped inductive switching (UIS)
- Low thermal resistance due to reduced chip thickness
- Enhanced total power density

## Applications

- Switched mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)
- Power factor correction (PFC)
- Welding
- Inductive heating
- PDP and LCD adapter

| Symbol                                        | Conditions                                                                                | Characteristic Values                                             |                       |      |                      |
|-----------------------------------------------|-------------------------------------------------------------------------------------------|-------------------------------------------------------------------|-----------------------|------|----------------------|
|                                               |                                                                                           | $(T_{VJ} = 25^\circ\text{C}, \text{ unless otherwise specified})$ |                       |      |                      |
|                                               |                                                                                           | min.                                                              | typ.                  | max. |                      |
| $R_{DS(on)}$                                  | $V_{GS} = 10 \text{ V}; I_D = 44 \text{ A}$                                               |                                                                   | 40                    | 45   | mΩ                   |
| $V_{GS(th)}$                                  | $V_{DS} = V_{GS}; I_D = 3 \text{ mA}$                                                     | 2.5                                                               | 3                     | 3.5  | V                    |
| $I_{DSS}$                                     | $V_{DS} = 600 \text{ V}; V_{GS} = 0 \text{ V}$                                            |                                                                   |                       | 10   | μA                   |
|                                               | $T_{VJ} = 25^\circ\text{C}$<br>$T_{VJ} = 125^\circ\text{C}$                               |                                                                   | 50                    |      | μA                   |
| $I_{GSS}$                                     | $V_{GS} = \pm 20 \text{ V}; V_{DS} = 0 \text{ V}$                                         |                                                                   |                       | 100  | nA                   |
| $C_{iss}$<br>$C_{oss}$                        | $V_{GS} = 0 \text{ V}; V_{DS} = 100 \text{ V}$<br>$f = 1 \text{ MHz}$                     |                                                                   | 6800<br>320           |      | pF<br>pF             |
| $Q_g$<br>$Q_{gs}$<br>$Q_{gd}$                 | $V_{GS} = 0 \text{ to } 10 \text{ V}; V_{DS} = 400 \text{ V}; I_D = 44 \text{ A}$         |                                                                   | 150<br>35<br>50       | 190  | nC<br>nC<br>nC       |
| $t_{d(on)}$<br>$t_r$<br>$t_{d(off)}$<br>$t_f$ | $V_{GS} = 10 \text{ V}; V_{DS} = 400 \text{ V}$<br>$I_D = 44 \text{ A}; R_G = 3.3 \Omega$ |                                                                   | 30<br>20<br>100<br>10 |      | ns<br>ns<br>ns<br>ns |
| $R_{thJC}$                                    |                                                                                           |                                                                   |                       | 0.2  | K/W                  |

<sup>1)</sup> CoolMOS™ is a trademark of Infineon Technologies AG.

**Source-Drain Diode**

| Symbol   | Conditions                                                                   | Characteristic Values |      |               |
|----------|------------------------------------------------------------------------------|-----------------------|------|---------------|
|          |                                                                              | min.                  | typ. | max.          |
| $I_S$    | $V_{GS} = 0\text{ V}$                                                        |                       |      | 44 A          |
| $V_{SD}$ | $I_F = 44\text{ A}; V_{GS} = 0\text{ V}$                                     | 0.9                   | 1.2  | V             |
| $t_{rr}$ | $I_F = 44\text{ A}; -di_F/dt = 100\text{ A}/\mu\text{s}; V_R = 400\text{ V}$ | 600                   |      | ns            |
| $Q_{RM}$ |                                                                              | 17                    |      | $\mu\text{C}$ |
| $I_{RM}$ |                                                                              | 60                    |      | A             |

**Component**

| Symbol    | Conditions      | Maximum Ratings |                    |
|-----------|-----------------|-----------------|--------------------|
| $T_{VJ}$  | operating       | -55...+150      | $^{\circ}\text{C}$ |
| $T_{stg}$ |                 | -55...+150      | $^{\circ}\text{C}$ |
| $M_d$     | mounting torque | 0.8 ... 1.2     | Nm                 |

| Symbol     | Conditions             | Characteristic Values |      |      |
|------------|------------------------|-----------------------|------|------|
|            |                        | min.                  | typ. | max. |
| $R_{thCH}$ | with heatsink compound | 0.25                  |      | K/W  |
| Weight     |                        | 6                     |      | g    |

## TO-247 AD Outline

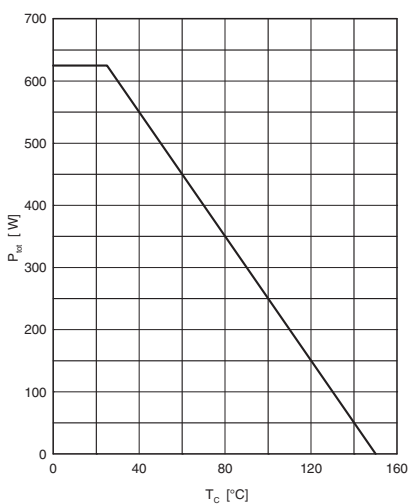
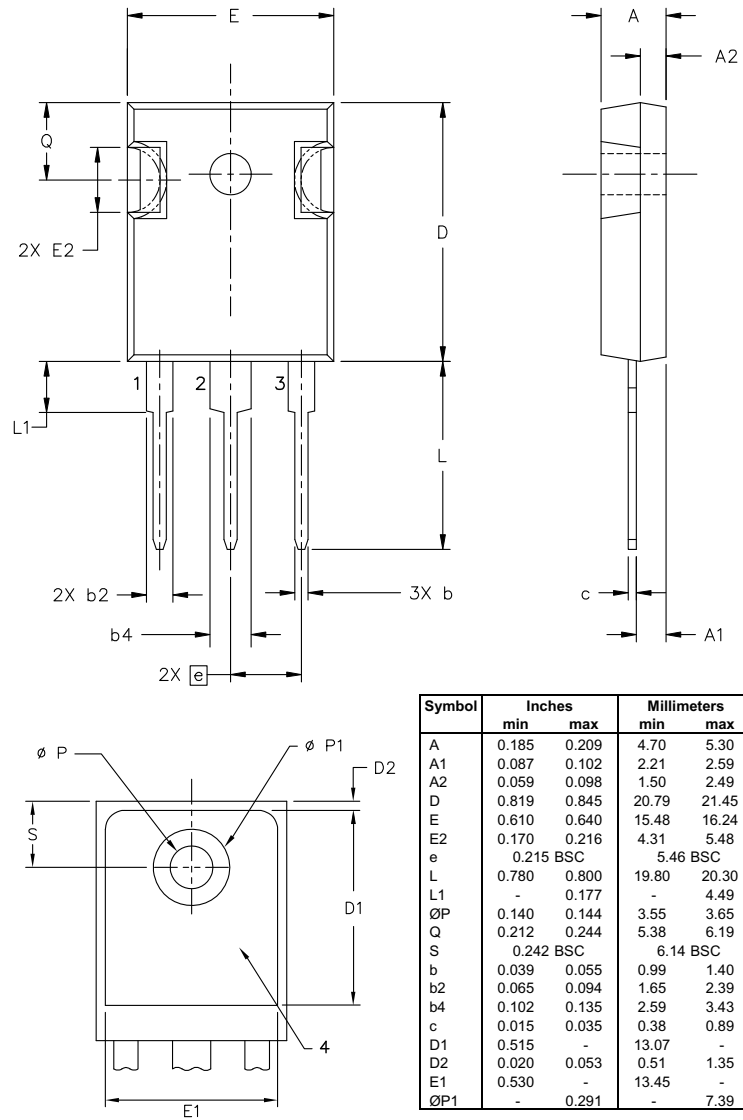


Fig. 1 Power dissipation

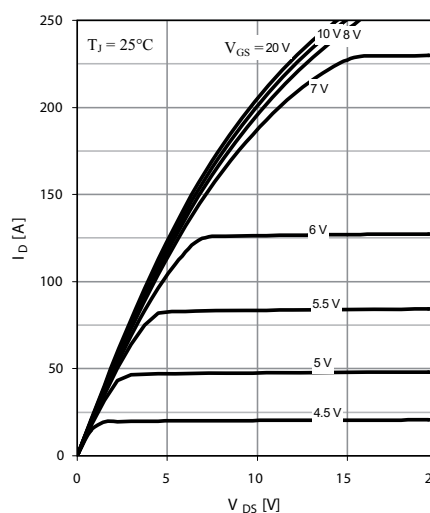


Fig. 2 Typ. output characteristics

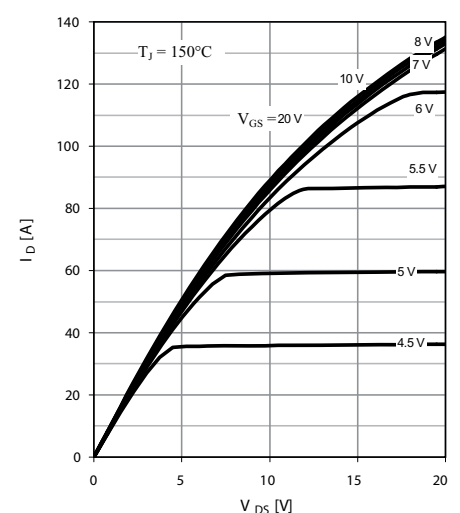


Fig. 3 Typ. output characteristics

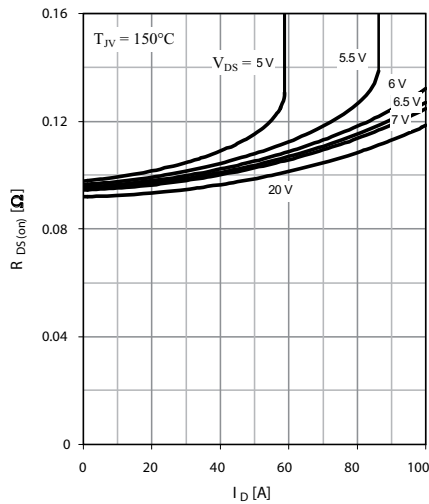


Fig. 4 Typ. drain-source on-state resistance characteristics of IGBT

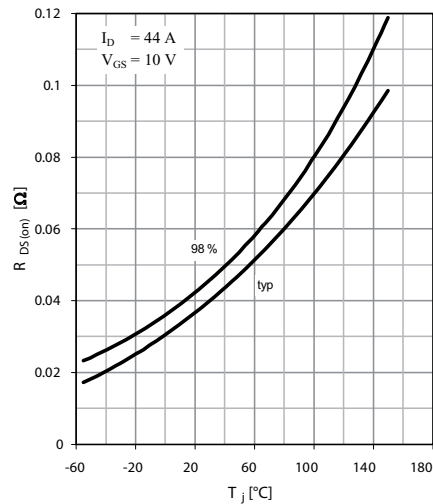


Fig. 5 Drain-source on-state resistance

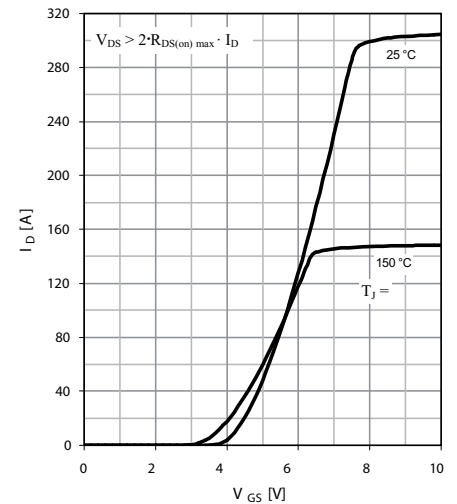


Fig. 6 Typ. transfer characteristics

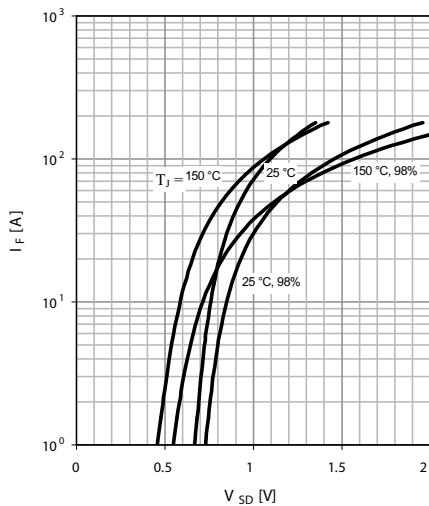


Fig. 7 Forward characteristic of reverse diode

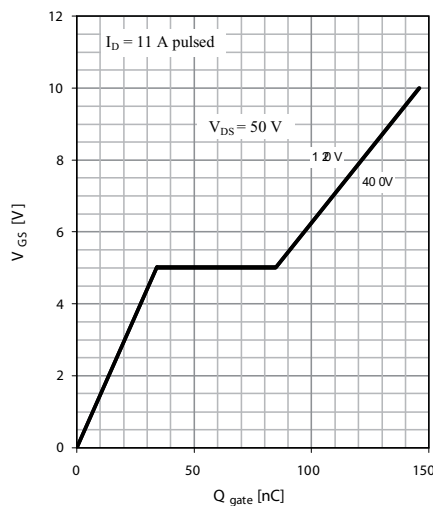


Fig. 8 Typ. gate charge

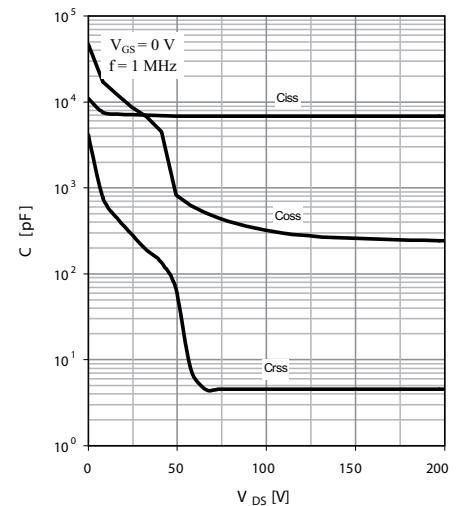


Fig. 9 Typ. capacitances

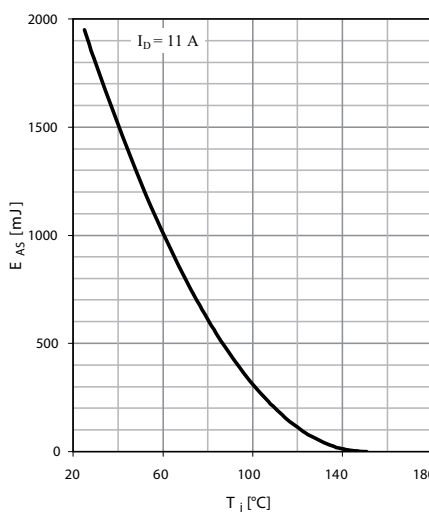


Fig. 10 Avalanche energy

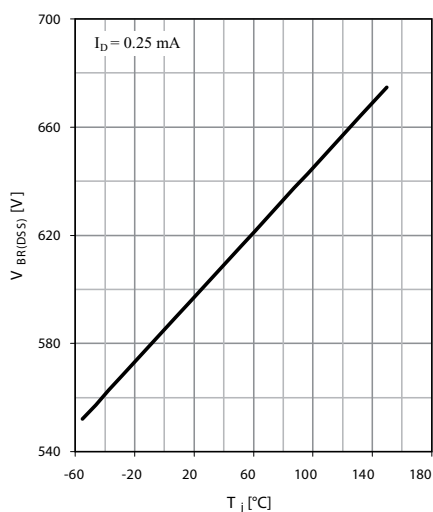


Fig. 11 Drain-source breakdown voltage

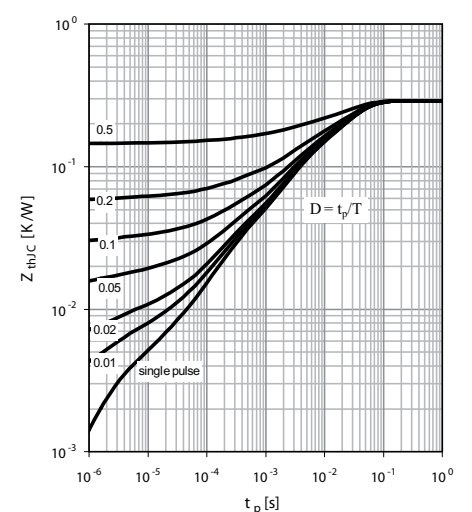


Fig. 12 Max. transient thermal impedance

IXYS reserves the right to change limits, test conditions and dimensions.

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